

## Description

This document details the custom configuration that is programmed into the one-time-programmable (OTP) memory of the 9FGV1005C011LTGI. Please refer to the device datasheet for further information about the device.

## General Configuration

Parameter	Value	Units
Device I <sup>2</sup> C Address	0xD0	—
Default Configuration at I <sup>2</sup> C Mode	0	—

## Frequency Overview

Parameter	Configuration 0	Configuration 1	Configuration 2	Configuration 3	Units
Input	39.0625	39.0625	39.0625	39.0625	MHz
REF 0	—	—	—	—	—
Output 0	156.25	161.1328125	312.5	322.265625	MHz
Output 1	156.25	161.1328125	312.5	322.265625	MHz

## Configuration 0 Parameters: SEL[1:0] = 00

Input frequency: 39.0625MHz; crystal load capacitance: 7.97pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	39.0625	156.25	156.25	MHz
Default Output Status	Off	On	On	—
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVC MOS	LP-HCSL	LP-HCSL	—
Spread Spectrum	—	—	—	%
Spread Spectrum Modulation	—	—	—	kHz
LP-HCSL Impedance	—	100	100	Ω

### Configuration 1 Parameters: SEL[1:0] = 01

Input frequency: 39.0625MHz; crystal load capacitance: 7.97pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	39.0625	161.1328125	161.1328125	MHz
Default Output Status	Off	On	On	—
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVC MOS	LP-HCSL	LP-HCSL	—
Spread Spectrum	—	—	—	%
Spread Spectrum Modulation	—	—	—	kHz
LP-HCSL Impedance	—	100	100	Ω

### Configuration 2 Parameters: SEL[1:0] = 10

Input frequency: 39.0625MHz; crystal load capacitance: 7.97pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	39.0625	312.5	312.5	MHz
Default Output Status	Off	On	On	—
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVC MOS	LP-HCSL	LP-HCSL	—
Spread Spectrum	—	—	—	%
Spread Spectrum Modulation	—	—	—	kHz
LP-HCSL Impedance	—	100	100	Ω

### Configuration 3 Parameters: SEL[1:0] = 11

Input frequency: 39.0625MHz; crystal load capacitance: 8.41pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	39.0625	322.265625	322.265625	MHz
Default Output Status	Off	On	On	—
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVC MOS	LP-HCSL	LP-HCSL	—
Spread Spectrum	—	—	—	%
Spread Spectrum Modulation	—	—	—	kHz
LP-HCSL Impedance	—	100	100	Ω

## Package Outline Drawings and Marking Diagrams

Refer to the [datasheet](#) for detailed information pertaining to package outline drawings and marking diagrams.

## Ordering Information

Orderable Part Number	Carrier Type	Temperature	Crystal
9FGV1005C011LTGI	Tray	-40° to +85°C	External
9FGV1005C011LTGI8	Tape and Reel	-40° to +85°C	External

## Revision History

Revision Date	Description of Change
September 16, 2020	Initial release.

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